

200mA, 36V DC/DC µModule

FEATURES

- Complete Step-Down Switch Mode Power Supply
- Wide Input Voltage Range: 4V to 36V
- 1.25V to 5V Output Voltage
- 200mA Output Current
- Current Mode Control
- Pb-Free (e4) RoHS Compliant Package with Gold Pad Finish
- Tiny, Low Profile (6.25mm × 6.25mm × 2.32mm)
 Surface Mount LGA Package

APPLICATIONS

- Automotive Battery Regulation
- Power for Portable Products
- Distributed Supply Regulation
- Industrial Supplies
- Wall Transformer Regulation

DESCRIPTION

The LTM®8020 is a complete 200mA, DC/DC step down power supply. Included in the package are the switching controller, power switches, inductor, and all support components. Operating over an input voltage range of 4V to 36V, the LTM8020 supports an output voltage range of 1.25V to 5V, set by a single resistor. Only bulk capacitors are needed to finish the design.

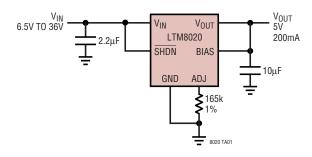
The low profile (2.32mm) tiny package enables utilization of unused space on the bottom of PC boards for high density point of load regulation.

The LTM8020 is packaged in a thermally enhanced, compact (6.25mm \times 6.25mm) and low profile (2.32mm) over-molded Land Grid Array (LGA) package suitable for automated assembly by standard surface mount equipment. The LTM8020 is Pb-free and RoHS compliant.

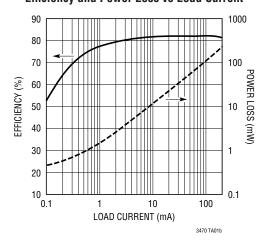
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TYPICAL APPLICATION

6.5V_{IN} to 36V_{IN}, 5V at 200mA DC/DC µModule Regulator



Efficiency and Power Loss vs Load Current

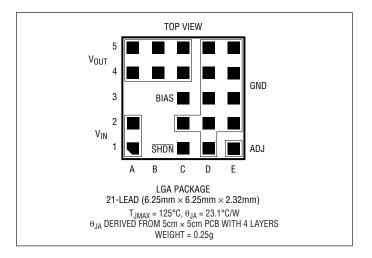


ABSOLUTE MAXIMUM RATINGS

(Note 1)

V _{IN} , SHDN Voltage	40V
ADJ Voltage	
BIAS Voltage	
V _{IN} + BIAS Voltage	
V _{OUT} Voltage	
Maximum Internal Temperature	125°C
Storage Temperature Range	40°C to 125°C
Lead Temperature (Soldering, 10 sec)	240°

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTM8020EV#PBF	LTM8020V	21-Lead (6.25mm × 6.25mm)	-40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/ This product is only offered in trays. For more information go to: http://www.linear.com/packaging/

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$. $V_{IN} = 10V$, $V_{\overline{SHDN}} = 10V$, $V_{BIAS} = 3V$, External $C_{IN} = 2.2\mu F$, $C_{OUT} = 4.7\mu F$. (Note 2)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V _{IN}	Input DC Voltage		•	4		36	V
V _{OUT}	Output DC Voltage	$0 < I_{OUT} \le 200 \text{mA}; 167 \text{k}\Omega < R_{ADJ} < \infty$		1.2		5	V
R _{ADJ(MIN)}	Minimum Allowable R _{ADJ}	(Note 3)		163			kΩ
I _{LK}	Leakage from IN to OUT	V _{SHDN} = 0V, BIAS = 0V			1.2	6	μА
I _{OUT}	Continuous Output DC Current	$5.5V \le V_{IN} \le 36V$, $R_{ADJ} = 301k$, $V_0 = 3.3V$		0		200	mA
IQ _{VIN}	Quiescent Current into IN	SHDN = 0.2V, BIAS OPEN BIAS = 3V, Not Switching BIAS = 0V, Not Switching	•		10 35	1 18 50	μΑ μΑ μΑ
IQ _{BIAS}	Quiescent Current into BIAS	SHDN = 0.2V, BIAS = 0V BIAS = 3V, Not Switching BIAS = 0V, Not Switching	•		25	0.5 60 1.5	μΑ μΑ μΑ
$\Delta V_{OUT}/V_{OUT}$	Line Regulation	$5V \le V_{IN} \le 36V$, $I_{OUT} = 200$ mA, R_{ADJ} Open			1		%
$\Delta V_{OUT}/V_{OUT}$	Load Regulation	$V_{IN} = 24V, 0 \le I_{OUT} \le 200 \text{mA}, V_{OUT} = 3.3V$			2		%

TECHNOLOGY TECHNOLOGY

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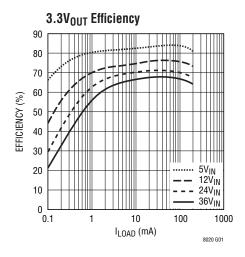
SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V _{OUT(AC_RMS)}	Output Ripple (RMS)	I _{OUT} = 100mA, V _{OUT} = 3.3V, V _{IN} = 24V			7.5		mV
f_{SW}	Switching Frequency	I _{OUT} = 200mA			450		kHz
I _{SC}	Output Short Circuit Current	V _{IN} = 36V, V _{OUT} = 0V			350		mA
$\overline{V_{ADJ}}$	Voltage at ADJ Pin		•	1.228		1.265	V
V _{BIAS(MIN)}	Minimum BIAS Voltage for Proper Operation		•	3			V
I _{ADJ}	Current Out of ADJ Pin	$ADJ = 0V, V_{OUT} = 5V, V_{\overline{SHDN}} = 0V$	•	9.65		10.35	μA
ISHDN	SHDN Pin Current	V _{SHDN} = 2.5V			1	5	μA
V _{IH(SHDN)}	SHDN Input High Voltage			2.5			V
V _{IL(SHDN)}	SHDN Input Low Voltage					0.2	V

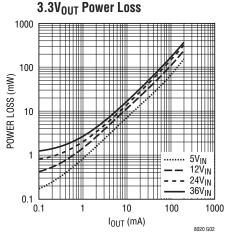
Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

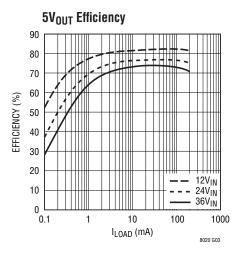
Note 2: The LTM8020E is guaranteed to meet performance specifications from 0°C to 85°C provided the maximum internal temperature rating is not exceeded. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: Guaranteed by design.

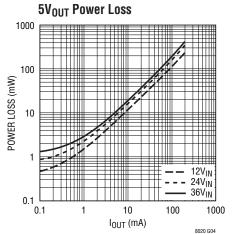
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted.

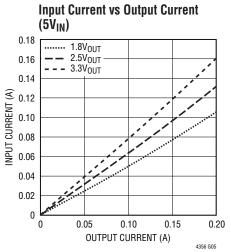


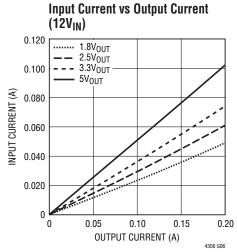


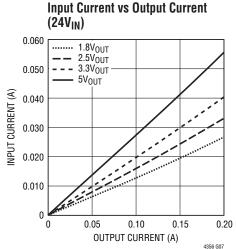


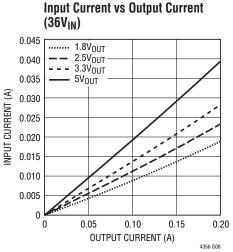
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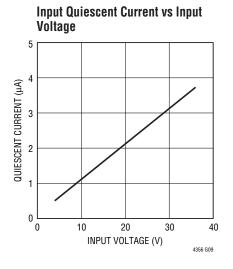


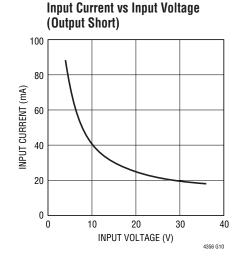


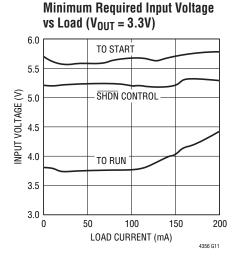


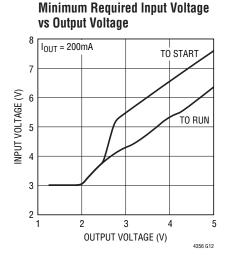






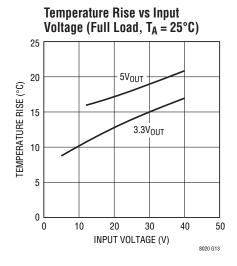


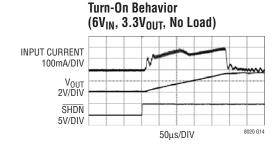




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TYPICAL PERFORMANCE CHARACTERISTICS T_A = 25°C unless otherwise noted.





PIN FUNCTIONS

 V_{IN} (Pins A1, A2): The V_{IN} pins supply current to the LTM8020's internal regulator and to the internal power switch. These pins must be locally bypassed with an external, low ESR capacitor of at least 1µF.

V_{OUT} (Pins A4, A5, B4, B5, C4, C5): Power Output Pins. An external capacitor is connected from V_{OUT} to GND in most applications. Apply output load between these pins and GND.

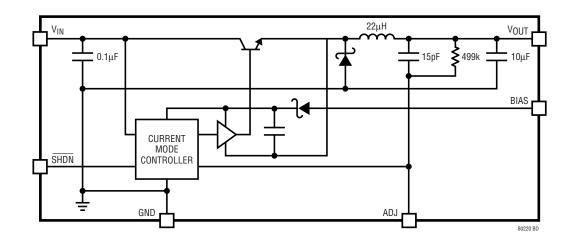
BIAS (Pin C3): The BIAS pin connects to the internal boost Schottky diode and to the internal regulator. Tie to V_{OUT} when $V_{OUT} > 3V$ or to another DC voltage greater than 3V otherwise. When BIAS > 3V the internal circuitry will be powered from this pin to improve efficiency. Main regulator power will still come from V_{IN}.

SHDN (Pin C1): The SHDN pin is used to put the LTM8020 in shutdown mode. Tie to ground to shut down the LTM8020. Apply 2V or more for normal operation. If the shutdown feature is not used, tie this pin to V_{IN} .

GND (Pins C2, D1, D2, D3, D4, D5, E2, E3, E4, E5): The GND connections serve as the main signal return and the primary heatsink for the LTM8020. Tie the GND pins to a local ground plane below the LTM8020 and the circuit components. Return the feedback divider to this signal.

ADJ (Pin E1): The LTM8020 regulates its ADJ pin to 1.25V. Connect the adjust resistor from this pin to GND. The value of this adjust resistor is determined by the equation R_{AD.I} = 623.75/(V_{OUT} – 1.25), where R_{ADJ} is in $k\Omega$. Note that the ADJ pin is open circuit if $V_{OLIT} = 1.25V$.

BLOCK DIAGRAM



OPERATION

The LTM8020 is a stand alone non-isolated step down switching DC/DC power supply. It can deliver up to 200mA of DC output current with only bulk external input and output capacitors. This module provides a precisely regulated output voltage programmable via one external resistor from 1.25VDC to 5VDC. The input voltage range is 4V to 36V. Given that the LTM8020 is a step down converter, make sure that the input voltage is high enough to support the desired output voltage and load current. See Block Diagram.

The LTM8020 contains a current mode controller, power switching element, power inductor, power Schottky diode and a modest amount of input and output capacitance. For some applications, as shown in Table 1, no output capacitor is necessary.

With its high performance current mode controller and internal feedback loop compensation, the LTM8020 module has sufficient stability margin and good transient performance under a wide range of operating conditions with a wide range of output capacitors, even all ceramic ones (X5R or X7R). Current mode control provides cycle-by-cycle fast

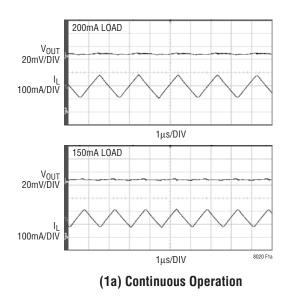
current limit, and automatic current limiting protects the module in the event of a short circuit or overload fault.

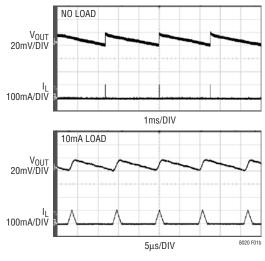
The LTM8020 is built upon a variable frequency controller. The on time, off time and switching frequency are dependent upon the input voltage, output voltage and load current.

The drive circuit for the internal power switching element is powered through the BIAS pin. Power this pin with at least 3V.

The LTM8020 is equipped with two operating modes, dependant upon the load current. When the load current is sufficiently high, the LTM8020 will switch continuously (see Figure 1a). If the load is very light, or if the input voltage is high relative to the output voltage, the part will operate in Burst Mode® operation, alternating between its micropower and switching states to keep the output in regulation and hold the power dissipation to a minimum (See Figure 1b).

If the \overline{SHDN} pin is grounded, all internal circuits are turned off and V_{IN} current reduces to the device leakage current, typically a few nano-amps.





(1b) Burst Mode Operation

Figure 1. Output Voltage and Internal Inductor Current

For most applications, the design process is straight forward, summarized as follows:

- 1. Look at Table 1 and find the row that has the desired input range and output voltage.
- 2. Apply the C_{IN} , C_{OUT} , R_{ADJ} and BIAS connection indicated on that row.

While these component combinations have been tested for proper operation, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

If an output voltage other than those listed in Table 1 is desired, use the equation $R_{ADJ} = 623.75/(V_{OUT} - 1.25)$, where R_{ADJ} is in $k\Omega$. As a starting point, use values for C_{IN} and C_{OUT} that correspond to the input voltage and output voltage that most closely matches the intended application, and verify proper operation over the system's line, load and environmental conditions.

Capacitor Selection Considerations

The C_{IN} and C_{OUT} capacitor values in Table 1 are the minimum recommended values for the associated operating conditions. Applying capacitor values below those indicated in Table 1 is not recommended, and may result in undesirable operation. An input system bulk capacitor is assumed. Using larger values is generally acceptable, and can yield improved dynamic response, if it is necessary. Again, it is incumbent upon the user to verify proper operation over the intended system's line, load and environmental conditions.

Ceramic capacitors are small, robust and have very low ESR. However, not all ceramic capacitors are suitable. X5R and X7R types are stable over temperature and applied voltage and give dependable service. Other types, including Y5V and Z5U have very large temperature and voltage coefficients of capacitance. In an application circuit they may have only a small fraction of their nominal capacitance resulting in much higher output voltage ripple than expected.

Ceramic capacitors are also piezoelectric. The LTM8020's switching frequency depends on the load current, and at light loads it can excite a ceramic capacitor at audio

frequencies, generating audible noise. Since the LTM8020 operates at a lower current limit during Burst Mode operation, the noise is typically very quiet to a casual ear.

If this audible noise is unacceptable, use a high performance electrolytic capacitor at the output. The input capacitor can be a parallel combination of a $2.2\mu F$ ceramic capacitor and a low cost electrolytic capacitor.

A final precaution regarding ceramic capacitors concerns the maximum input voltage rating of the LTM8020. A ceramic input capacitor combined with trace or cable inductance forms a high Q (under damped) tank circuit. If the LTM8020 circuit is plugged into a live supply, the input voltage can ring to twice its nominal value, possibly exceeding the device's rating. This situation is easily avoided; see the Hot-Plugging Safely section.

Shorted Input Protection

Care needs to be taken in systems where the output will be held high when the input to the LTM8020 is absent. This may occur in battery charging applications or in battery backup systems where a battery or some other supply is diode OR'ed with the LTM8020's output. If the V_{IN} pin is allowed to float and the SHDN pin is held high (either by a logic signal or because it is tied to V_{IN}), then the LTM8020's internal circuitry will pull its quiescent current through its SW pin. This is fine if your system can tolerate a few milli-amps in this state. If you ground the SHDN pin, the SW pin current will drop to essentially zero. However, if the V_{IN} pin is grounded while the output is held high, then parasitic diodes inside the LTM8020 can pull large currents from the output through the SW pin and the V_{IN} pin. Figure 2 shows a circuit that will run only when the input voltage is present and that protects against a shorted or reversed input.

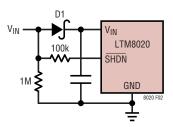


Figure 2. Diode D1 Prevents a Shorted Input from Discharging a Backup Battery Tied to the Output, as Well as Protecting the LTM8020 from a Reversed Input

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PCB Layout

Most of the headaches associated with PCB layout have been alleviated or even eliminated by the high level of integration of the LTM8020. The LTM8020 is never-theless a switching power supply, and care must be taken to minimize EMI and ensure proper operation. Even with the high level of integration, you may fail to achieve specified operation with a haphazard or poor layout. See Figure 3 for a suggested layout.

Ensure that the grounding and heatsinking are acceptable. A few rules to keep in mind are:

- 1. Place the C_{IN} capacitor as close as possible to the V_{IN} and GND connection of the LTM8020.
- 2. Place the C_{OUT} capacitor as close as possible to the V_{OUT} and GND connection of the LTM8020.
- 3. Place the C_{IN} and C_{OUT} capacitors such that their ground current flows directly adjacent or underneath the LTM8020.
- 4. Connect all of the GND connections to as large a copper pour or plane area as possible on the top layer. Avoid breaking the ground connection between the external components and the LTM8020.
- 5. The copper pours also serve as the heatsink for the LTM8020. Place several vias in the GND plane to act as heat pipes to other layers of the printed circuit board.

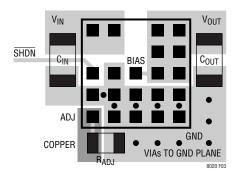


Figure 3. Layout showing suggested external components, GND plane and thermal vias

Positive to Negative Voltage Regulation

The LTM8020 can generate a negative output by tying the V_{OUT} pads to system ground and connecting GND as shown in the Typical Applications section. In this configuration, \overline{SHDN} must be level shifted or referenced to GND, and the available output current may be reduced.

Hot-Plugging Safely

The small size, robustness and low impedance of ceramic capacitors make them an attractive option for the input bypass capacitor of LTM8020. However, these capacitors can cause problems if the LTM8020 is plugged into a live supply (see Linear Technology Application Note 88 for a complete discussion). The low loss ceramic capacitor combined with stray inductance in series with the power source forms an under damped tank circuit, and the voltage at the V_{IN} pin of the LTM8020 can ring to twice the nominal input voltage, possibly exceeding the LTM8020's rating and damaging the part. If the input supply is poorly controlled or the user will be plugging the LTM8020 into an energized supply, the input network should be designed to prevent this overshoot. Figure 4 shows the waveforms that result when an LTM8020 circuit is connected to a 24V supply through six feet of 24-gauge twisted pair. The first plot is the response with a 2.2µF ceramic capacitor at the input. The input voltage rings as high as 35V and the input current peaks at 20A. One method of damping the tank circuit is to add another capacitor with a series resistor to the circuit. In Figure 4b an aluminum electrolytic capacitor has been added. This capacitor's high equivalent series resistance damps the circuit and eliminates the voltage overshoot. The extra capacitor improves low frequency ripple filtering and can slightly improve the efficiency of the circuit, though it is likely to be the largest component in the circuit. An alternative solution is shown in Figure 4c. A 1Ω resistor is added in series with the input to eliminate the voltage overshoot (it also reduces the peak input current). A 0.1µF capacitor improves high frequency filtering. This solution is smaller and less expensive than the electrolytic capacitor. For high input voltages its impact on efficiency is minor, reducing efficiency less than one half percent for a 5V output at full load operating from 24V.



High Temperature Considerations

The die temperature of the LTM8020 must be lower than the maximum rating of 125°C, so care should be taken in the layout of the circuit to ensure good heat sinking of the LTM8020. To estimate the junction temperature, approximate the power dissipation within the LTM8020 by applying the typical efficiency stated in this datasheet to the desired output power, or, if you have an actual module, by taking a power measurement. Then calculate the internal temperature rise of the LTM8020 above the surface of the printed circuit board by multiplying the module's power dissipation by the thermal resistance. The actual thermal resistance of the LTM8020 to the printed circuit board depends upon the layout of the circuit board, but the thermal resistance given on page 2, which is based upon a 25cm² 4-layer FR4 PC board, and the Typical Performance Characteristics can be used a quide.

Finally, be aware that at high ambient temperatures the internal Schottky diode will have significant leakage current increasing the quiescent current of the LTM8020.

BIAS Pin Considerations

The BIAS pin is used to provide drive power for the internal power switching stage and operate internal circuitry. For proper operation, it must be powered by at least 3V. If the output voltage is programmed to be 3V or higher, simply tie BIAS to V_{OUT} . If V_{OUT} is less than 3V, BIAS can be tied to VIN or some other voltage source. In all cases, ensure that the maximum voltage at the BIAS pin is both less than 25V and the sum of V_{IN} and BIAS is less than 47V. If BIAS power is applied from a remote or noisy voltage source, it may be necessary to apply a decoupling capacitor locally to the LTM8020.

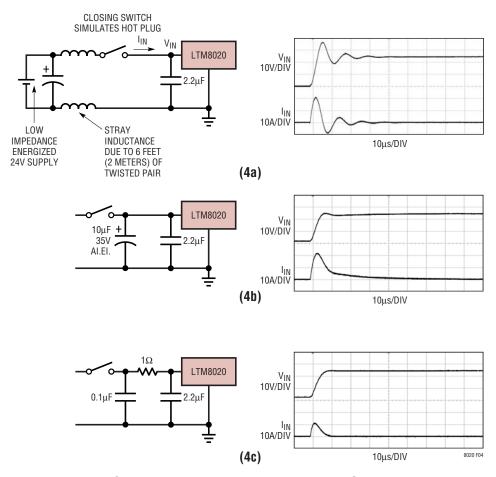


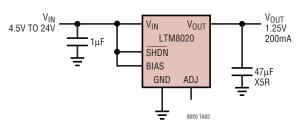
Figure 4. A Well Chosen Input Network Prevents Input Voltage Overshoot and Ensures Reliable Operation When the LTM8020 is Connected to a Live Supply

Table 1. Recommended External Component Values and Configuration

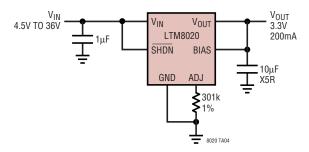
V _{IN} Range	V _{OUT}	C _{IN}	C _{OUT}	R _{ADJ}	BIAS Connection
4.5V - 36V	1.25V	2.2µF 50V 1206 X7R	47μF 6.3V 1206 X5R	Open	>2V, < 25V
4.5V - 36V	1.5V	2.2µF 50V 1206 X7R	47μF 6.3V 1206 X5R	2.43M	>2V, < 25V
4.5V - 36V	1.8V	2.2µF 50V 1206 X7R	47μF 6.3V 1206 X5R	1.1M	>2V, < 25V
4.5V - 36V	2.5V	2.2µF 50V 1206 X7R	22µF 6.3V 1206 X7R	499k	V _{OUT}
4.5V - 36V	3.3V	2.2µF 50V 1206 X7R	10μF 6.3V 1206 X7R	301k	V _{OUT}
6.5V - 36V	5V	2.2µF 50V 1206 X7R	10μF 6.3V 1206 X7R	165k	V _{OUT}
4.5V - 15V	1.25V	2.2µF 16V 0805 X7R	22µF 6.3V 1206 X7R	Open	V _{IN}
4.5V - 15V	1.5V	2.2µF 16V 0805 X7R	10μF 6.3V 0805 X7R	2.43M	V _{IN}
4.5V - 15V	1.8V	2.2µF 16V 0805 X7R	10μF 6.3V 0805 X7R	1.1M	V _{IN}
4.5V - 15V	2.5V	2.2µF 16V 0805 X7R	10μF 6.3V 0805 X7R	499k	V _{IN}
4.5V - 15V	3.3V	2.2µF 16V 0805 X7R	10μF 6.3V 0805 X7R	301k	V _{OUT}
6.5V - 15V	5V	2.2µF 16V 0805 X7R	None	165k	V _{OUT}
9V - 24V	1.25V	1μF 25V 0805 X7R	47μF 6.3V 0805 X5R	Open	V _{IN}
9V - 24V	1.5V	1μF 25V 0805 X7R	47μF 6.3V 0805 X7R	2.43M	V _{IN}
9V - 24V	1.8V	1μF 25V 0805 X7R	10μF 6.3V 0805 X7R	1.1M	V _{IN}
9V - 24V	2.5V	1μF 25V 0805 X7R	10μF 6.3V 0805 X7R	499k	V _{IN}
9V - 24V	3.3V	1μF 25V 0805 X7R	10μF 6.3V 0805 X7R	301k	V _{OUT}
9V - 24V	5V	4.7μF 25V 0805 X7R	10μF 6.3V 0805 X5R	165k	V _{OUT}
18V - 36V	1.25V	2.2µF 50V 1206 X7R	47μF 6.3V 1206 X5R	Open	>2V, <25V
18V - 36V	1.5V	2.2µF 50V 1206 X7R	47μF 6.3V 1206 X5R	2.43M	>2V, <25V
18V - 36V	1.8V	2.2μF 50V 1206 X7R	22µF 6.3V 1206 X7R	1.1M	>2V, <25V
18V - 36V	2.5V	2.2µF 50V 1206 X7R	10μF 6.3V 0805 X7R	499k	V _{OUT}
18V - 36V	3.3V	2.2μF 50V 1206 X7R	10μF 6.3V 0805 X7R	301k	V _{OUT}
18V - 36V	5V	2.2μF 50V 1206 X7R	10μF 6.3V 0805 X7R	165k	V _{OUT}
3.3V - 30V	-3.3V	2.2µF 50V 1206 X7R	22µF 6.3V 0805 X7R	301k	V _{OUT}
5V - 30V	-5V	2.2µF 50V 1206 X7R	10μF 6.3V 0805 X7R	165k	V _{OUT}

TYPICAL APPLICATIONS

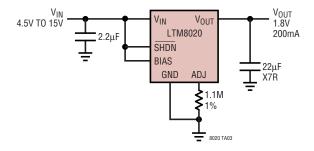
1.25V Step-Down Converter



3.3V Step-Down Converter

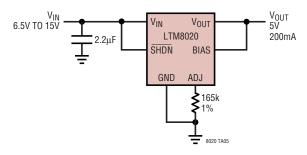


1.8V Step-Down Converter

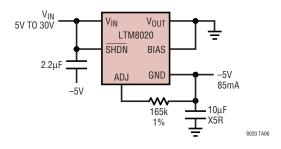


TYPICAL APPLICATIONS

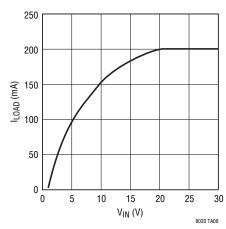
5V Step-Down Converter (No Output Capacitor Required)



-5V Positive to Negative Converter



-5V Positive to Negative Converter Output vs Input Voltage



PACKAGE DESCRIPTION

C(0.30) PAD 1 က PACKAGE IN TRAY LOADING ORIENTATION **→** 0.605 - 0.665 **BOTTOM VIEW** 5.080 LTMXXXXXX µModule 1 TRAY PIN 1 1.270 BSC 0.605 - 0.665COMPONENT_ PIN "A1" PADS__ SEE NOTES__ 5.080 BSC -0.27 - 0.37SUBSTRATE **21-Lead (6.25mm** \times **6.25mm** \times **2.32mm)** (Reference LTC DWG # 05-08-1803 Rev A) 3 LAND DESIGNATION PER JESD MO-222, SPP-010 AND SPP-020 NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994 DETALS OF PAD #1 IDENTIFIER ARE OPTIONAL,
BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
THE PAD #1 IDENTIFIER MAY BE EITHER A MOLD OR A
MARKED FEATURE Z DETAIL A MOLD [Z |qqq| 🖵 5. PRIMARY DATUM -Z- IS SEATING PLANE 2. ALL DIMENSIONS ARE IN MILLIMETERS 1.95 - 2.056. THE TOTAL NUMBER OF PADS: 21 DETAIL A PACKAGE SIDE VIEW 2.22 – 2.42 SYMBOL TOLERANCE 0.15 aaa Z aaa 6.250 BSC > × 2.5400 SUGGESTED PCB LAYOUT 0072.1 PACKAGE TOP VIEW 6.250 BSC 0000.0 0072. 2.5400 ─ aaa Z — 2.5400 -1.5875 -1.2700 -0.9525 -0.0000 2.5400 -1.2700

LINEAR TECHNOLOGY

LGA Package

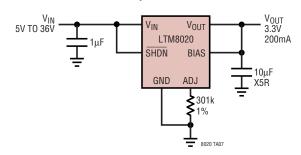
PACKAGE DESCRIPTION

LTM8020 Pinout (Sorted by Pin Number)

-1 MOOZO 1 MOUL (SOILEU DY 1 M NUMBEI)			
PIN	SIGNAL DESCRIPTION		
A1	V _{IN}		
A2	V _{IN}		
A4	V _{OUT}		
A5	V _{OUT}		
B4	V _{OUT}		
B5	V _{OUT}		
C1	SHDN		
C2	GND		
C3	BIAS		
C4	V _{OUT}		
C5	V _{OUT}		
D1	GND		
D2	GND		
D3	GND		
D4	GND		
D5	GND		
E1	ADJ		
E2	GND		
E3	GND		
E4	GND		
E5	GND		

TYPICAL APPLICATION

3.3V Step-Down Converter



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTM4600	10A DC/DC μModule	Basic 10A DC/DC μModule, 15mm × 15mm × 2.8mm LGA
LTM4600HVMPV	Military Plastic 10A DC/DC μModule	-55°C to 125°C Operation, 15mm × 15mm × 2.8mm LGA
LTM4601/ LTM4601A	12A DC/DC µModule with PLL, Output Tracking/Margining and Remote Sensing	Synchronizable, PolyPhase Operation, LTM4601-1 Version has no Remote Sensing
LTM4602	6A DC/DC μModule	Pin Compatible with the LTM4600
LTM4603	6A DC/DC μModule with PLL and Output Tracking/ Margining and Remote Sensing	Synchronizable, PolyPhase Operation, LTM4603-1 Version has no Remote Sensing, Pin Compatible with the LTM4601
LTM4604	4A Low V _{IN} DC/DC μModule	$2.375V \le V_{IN} \le 5V$, $0.8V \le V_{OUT} \le 5V$, $9mm \times 15mm \times 2.3mm$ LGA
LTM4608	8A Low V _{IN} DC/DC μModule	$2.375V \le V_{IN} \le 5V$, $0.8V \le V_{OUT} \le 5V$, $9mm \times 15mm \times 2.8mm$ LGA
LTM8022	1A, 36V DC/DC μModule	Adjustable Frequency, $0.8V \le V_{OUT} \le 5V$, $11.25mm \times 9mm \times 2.82mm$, Pin Compatible to the LTM8023
LTM8023	2A, 36V DC/DC μModule	Adjustable Frequency, 0.8V \leq V $_{OUT}$ \leq 5V, 11.25mm \times 9mm \times 2.82mm, Pin Compatible to the LTM8022